

# Discontinued

# SF1186G-6

1575.5 MHz

**SAW Filter** 

#### • RF filter designed for front end GPS applications

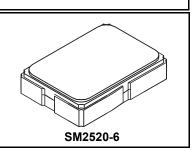
Low Insertion Loss

- Complies with Directive 2002/95/EC (RoHS)

• 2.0 x 2.5 x 0.75 mm Surface Mount Case

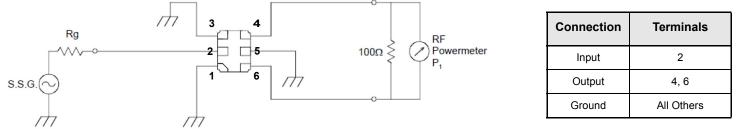
#### **Absolute Maximum Ratings**

Rating	Value	Units
Input Power Level	+17	dBm
DC Voltage	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C



### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Мах	Units	
Center Frequency	F <sub>C</sub>			1575.42		MHz	
Insertion Loss, 1574 to 1577 MHz				1.5	1.9	dB	
Amplitude Ripple, 1574 to 1577 MHz				0.2 0.5			
VSWR, 1574 to 1577 MHz				1.5	1.8		
Amplitude Balance 1574 to 1577 MHz			-1.6	±1.3	+1.6	dB	
Phase Balance 1574 to 1577 MHz			170	180±4	190	deg	
Attenuation Referenced to 0 dB:							
100 to 1475 MHz			30	47			
1475 to 1525 MHz			15	33		40	
1625 to 1675 MHz			9	22		dB	
1675 to 3000 MHz			30	33			
3000 to 6000 MHz			25	30		-	
Case Style		SM2520-6 Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot = pin 1 indicator	5A, YWWS						
Standard Reel Quantity Reel Size 7 Inch	2,000 Pieces/Reel						
Reel Size 13 Inch	10,000 Pieces/Reel						

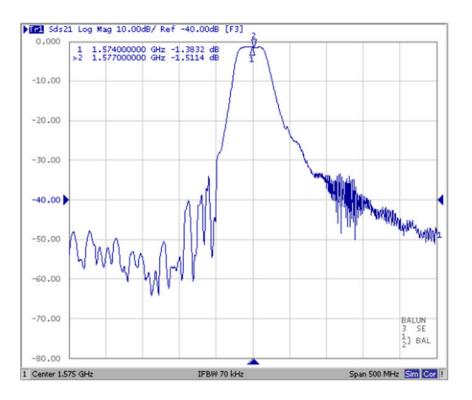


### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

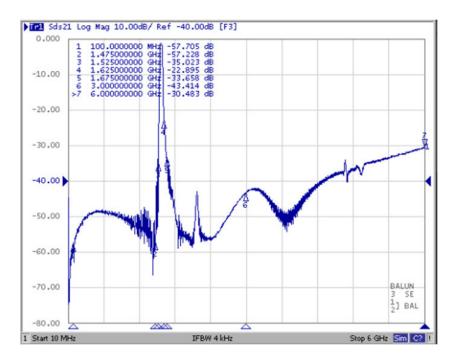
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance 1. matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
- 2. 3.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- 4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are subject to change.
- 6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 7.
- US and international patents may apply. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd. 8.

# **Frequency Characteristics**

S21 Response (span 500 MHz)

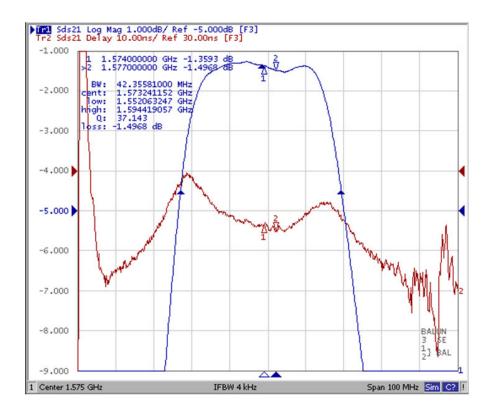


### S21 Response (span 6 GHz)

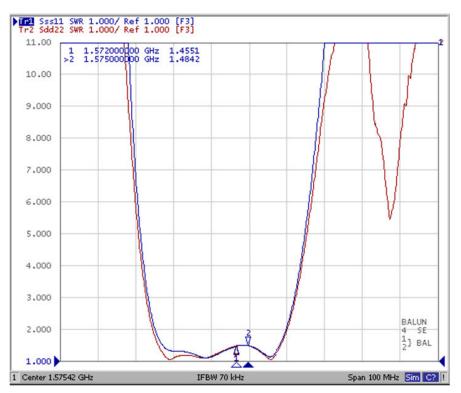


# Frequency Characteristics (continued)

S21 Response (span 100 MHz)



### S11 and S22 VSWR (span 6 GHz)



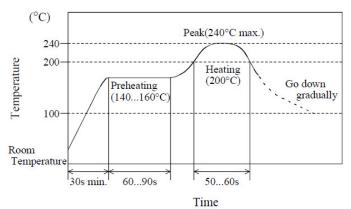
# **Physical and Environmental Characteristics**

Test Item	Test Condition	Criteria
PCB Bend Strength	Filter is soldered onto the center of 0.8mm thickness PCB which is laid on the two small supporters spaced 90mm as shown in below figure. PCB is deflected to 2mm below from horizontal level by the pressing stick. The force is supplied for 1 second - 5 times repeatedly. Pressing Stick Unit:mm 20 $10$ Load PCB R10 $45$ Supporter $2$ 45 Supporter $2$	No visible damage should be induced.
Vibration	The electrical performance is measured after being applied vibration of amplitude of 1.5mm with 10 to 55Hz of vibration frequency to each of 3 perpendicular directions for 2 hours.	
Drop Test	The electrical performance is measured after dropping with housing (around 100g) from a height of 150cm onto the concrete plate 3 times in each of 6 perpendicular directions.	
Solderability	Terminals are immersed in rosin flux (concentration 2025%, solvent: ethanol 7580%) for 5 seconds, then immersed in soldering bath at $230\pm5^{\circ}$ C (solder: JIS-Z-3282 H63A, H60A or Sn-3.0Ag-0.5Cu) for 5±0.5 seconds.	90% minimum of the immersed surface should be covered with solder.
Resistance to Soldering Heat	Filter is preheated at 170±10°C for 90 seconds, immersed whole elec- trode in soldering bath at 255±5°C for 3±1seconds, then measured after being placed in standard atmospheric conditions for 2 hours.	
Humidity	The electrical performance is measured after being placed in a cham- ber with 9095% R.H. at 60°C for 500 hours and then being placed in standard atmospheric conditions for 2 hours.	
Life Test (High Temperature)	The electrical performance is measured after being placed in a cham- ber with 85°C for 500 hours and then being placed in standard atmo- spheric conditions for 2 hours.	
Life Test (Low Temperature)	The electrical performance is measured after being placed in a cham- ber with -40°C for 500 hours and then being placed in standard atmo- spheric conditions for 2 hours.	
Thermal Shock	After temperature cycling of -55°C for 30 minutes to +85°C for 30 minutes performed 100 times, filter shall be returned to room temperature. And the electrical performance is measured after being placed in stan- dard atmospheric conditions for 2 hours.	
Resistance to Reflow Soldering	The electrical performance is measured after being soldered by reflow 2 times with the following reflow profile A or B and then being placed in standard atmospheric conditions for 24 hours.	

# **Reflow Profile**

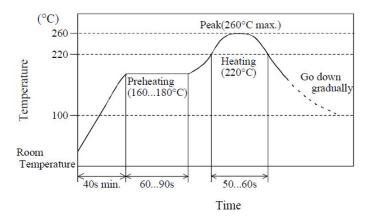
### **Profile A**

- 1. 2. 3.
- Preheating shall be fixed at 140...160°C for 60...90 seconds. Ascending time to preheating temperature 150°C shall be 30 seconds minimum. Heating shall be fixed at 200°C for 50...60 seconds and at  $230\pm10^{\circ}$ C peak.



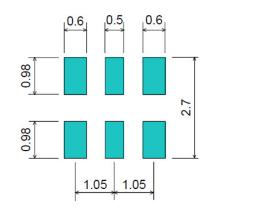
### **Profile B**

- 1.
- Preheating shall be fixed at 160...180°C for 60...90 seconds. Ascending time to preheating temperature 170°C shall be 40 seconds minimum. Heating shall be fixed at 220°C for 50...60 seconds and at 255±5°C peak. 2. 3.



## **Recommended Land Pattern**

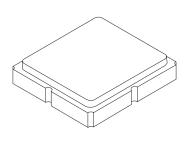
1. Recommended land pattern is as follows.





# SM2520-6 Case

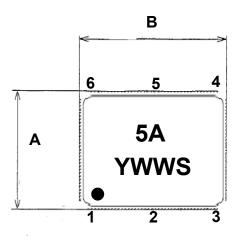
# 6-Terminal Ceramic Surface-Mount Case 2.5 X 2.0 mm Nominal Footprint

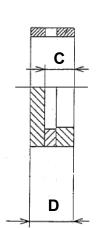


### **Case and PCB Footprint Dimensions**

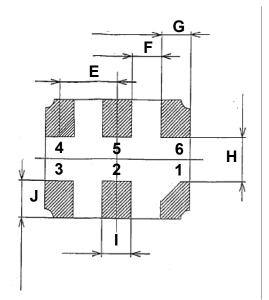
Dimension	mm			Inches			
Dimension	Min	Nom	Max	Min	Nom	Max	
Α	-	2.00	-	-	0.078	-	
В	-	2.50	-	-	0.098	-	
С	-	0.50	-	-	0.029	-	
D	-	0.75	-	-	0.019	-	
E	-	1.00	-	-	0.039	-	
F	-	0.50	-	-	0.019	-	
G	-	0.50	-	-	0.019	-	
Н	-	0.74	-	-	0.029	-	
I	-	0.50	-	-	0.019	-	
J	-	0.63	-	-	0.024	-	

**TOP VIEW** 

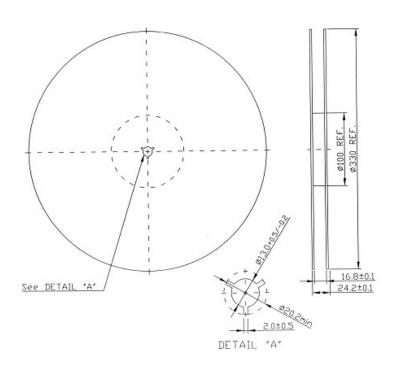








### **Tape and Reel Specifications**



-	'B"	Quantity Per Reel
Inches	millimeters	
7	178	2000
13	330	10000

### **COMPONENT ORIENTATION and DIMENSIONS**

